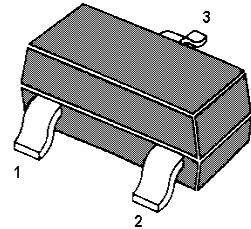
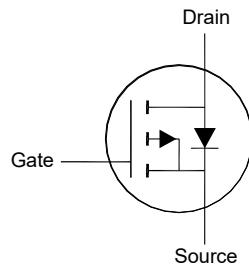


MMFTP2317

P-Channel Enhancement Mode MOSFET

Features

- Surface-mounted package



1. Gate 2. Source 3. Drain
SOT-23 Plastic Package

Applications

- High speed switch
- Portable appliances
- Battery management

Absolute Maximum Ratings(at $T_a = 25^\circ\text{C}$ unless otherwise specified)

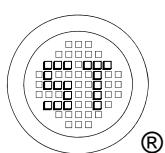
| Parameter | Symbol | Value | Unit |
|--|----------------|---------------|------|
| Drain-Source Voltage | $-V_{DS}$ | 20 | V |
| Gate-Source Voltage | V_{GS} | ± 10 | V |
| Continuous Drain Current | $-I_D$ | 4.2 | A |
| Pulsed Drain Current ¹⁾ | $-I_{DM}$ | 25 | A |
| Power Dissipation ²⁾ $t \leq 10 \text{ s}$ Steady State | P_D | 1.38 0.75 | W |
| Operating Junction and Storage Temperature Range | T_j, T_{stg} | - 55 to + 150 | °C |

Thermal Resistance Ratings

| Parameter | Symbol | Max. | Unit |
|--|-----------------|-----------|------|
| Thermal Resistance from Junction to Ambient ²⁾ $t \leq 10 \text{ s}$ Steady State | $R_{\theta JA}$ | 90 166 | °C/W |

¹⁾ Pulse Test: Pulse Width $\leq 100 \mu\text{s}$, Duty Cycle $\leq 2\%$, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150^\circ\text{C}$.

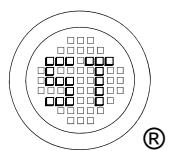
²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.



MMFTP2317

Characteristics at $T_a = 25^\circ\text{C}$ unless otherwise specified

| Parameter | Symbol | Min. | Typ. | Max. | Unit |
|---|------------------------------|-------------|-------------|----------------|------------------|
| STATIC PARAMETERS | | | | | |
| Drain-Source Breakdown Voltage at $-I_D = 250 \mu\text{A}$ | $-V_{(\text{BR})\text{DSS}}$ | 20 | - | - | V |
| Zero Gate Voltage Drain Current at $-V_{\text{DS}} = 20 \text{ V}$ | $-I_{\text{DSS}}$ | - | - | 1 | μA |
| Gate-Source Leakage at $V_{\text{GS}} = \pm 10 \text{ V}$ | I_{GSS} | - | - | ± 100 | nA |
| Gate-Source Threshold Voltage at $V_{\text{DS}} = V_{\text{GS}}, -I_D = 250 \mu\text{A}$ | $-V_{\text{GS}(\text{th})}$ | 0.3 | - | 1 | V |
| Drain-Source On-State Resistance at $-V_{\text{GS}} = 4.5 \text{ V}, -I_D = 4 \text{ A}$ at $-V_{\text{GS}} = 2.5 \text{ V}, -I_D = 3 \text{ A}$ at $-V_{\text{GS}} = 1.8 \text{ V}, -I_D = 1 \text{ A}$ | $R_{\text{DS}(\text{on})}$ | - - - | - - - | 52 65 90 | $\text{m}\Omega$ |
| DYNAMIC PARAMETERS | | | | | |
| Forward Transconductance at $-V_{\text{DS}} = 5 \text{ V}, -I_D = 4 \text{ A}$ | g_{fs} | - | 12.4 | - | S |
| Gate resistance at $V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1 \text{ MHz}$ | R_g | - | 4.7 | - | Ω |
| Input Capacitance at $-V_{\text{DS}} = 10 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1 \text{ MHz}$ | C_{iss} | - | 535 | - | pF |
| Output Capacitance at $-V_{\text{DS}} = 10 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1 \text{ MHz}$ | C_{oss} | - | 91 | - | pF |
| Reverse Transfer Capacitance at $-V_{\text{DS}} = 10 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1 \text{ MHz}$ | C_{rss} | - | 64 | - | pF |
| Total Gate Charge at $-V_{\text{GS}} = 4.5 \text{ V}, -V_{\text{DS}} = 10 \text{ V}, -I_D = 4 \text{ A}$ at $-V_{\text{GS}} = 2.5 \text{ V}, -V_{\text{DS}} = 10 \text{ V}, -I_D = 4 \text{ A}$ | Q_g | - - | 5.7 3.3 | - | nC |
| Gate-Source Charge at $-V_{\text{GS}} = 4.5 \text{ V}, -V_{\text{DS}} = 10 \text{ V}, -I_D = 4 \text{ A}$ | Q_{gs} | - | 1.7 | - | nC |
| Gate-Drain Charge at $-V_{\text{GS}} = 4.5 \text{ V}, -V_{\text{DS}} = 10 \text{ V}, -I_D = 4 \text{ A}$ | Q_{gd} | - | 1.6 | - | nC |
| Turn-On Delay Time at $-V_{\text{DD}} = 10 \text{ V}, -V_{\text{GS}} = 10 \text{ V}, -I_D = 4 \text{ A}, R_g = 3.3 \Omega$ | $t_{\text{d}(\text{on})}$ | - | 7 | - | ns |
| Turn-On Rise Time at $-V_{\text{DD}} = 10 \text{ V}, -V_{\text{GS}} = 10 \text{ V}, -I_D = 4 \text{ A}, R_g = 3.3 \Omega$ | t_r | - | 42 | - | ns |
| Turn-Off Delay Time at $-V_{\text{DD}} = 10 \text{ V}, -V_{\text{GS}} = 10 \text{ V}, -I_D = 4 \text{ A}, R_g = 3.3 \Omega$ | $t_{\text{d}(\text{off})}$ | - | 10 | - | ns |
| Turn-Off Fall Time at $-V_{\text{DD}} = 10 \text{ V}, -V_{\text{GS}} = 10 \text{ V}, -I_D = 4 \text{ A}, R_g = 3.3 \Omega$ | t_f | - | 7 | - | ns |
| Body-Diode PARAMETERS | | | | | |
| Body Diode Voltage at $-I_s = 1.2 \text{ A}$ | $-V_{\text{SD}}$ | - | - | 1.2 | V |
| Body-Diode Continuous Current | $-I_s$ | - | - | 4.2 | A |
| Body Diode Reverse Recovery Time at $-I_s = 4 \text{ A}, \text{di/dt} = 100 \text{ A} / \mu\text{s}$ | t_{rr} | - | 5.6 | - | ns |
| Body Diode Reverse Recovery Charge at $-I_s = 4 \text{ A}, \text{di/dt} = 100 \text{ A} / \mu\text{s}$ | Q_{rr} | - | 0.6 | - | nC |



Electrical Characteristics Curves

Fig. 1 Typical Output Characteristics

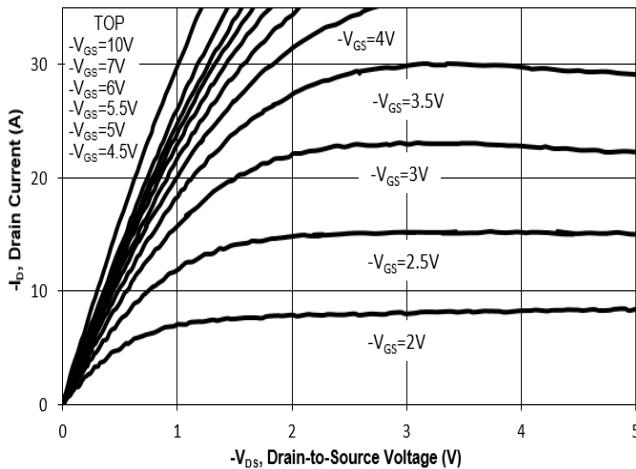


Fig. 3 On-Resistance vs. Drain Current

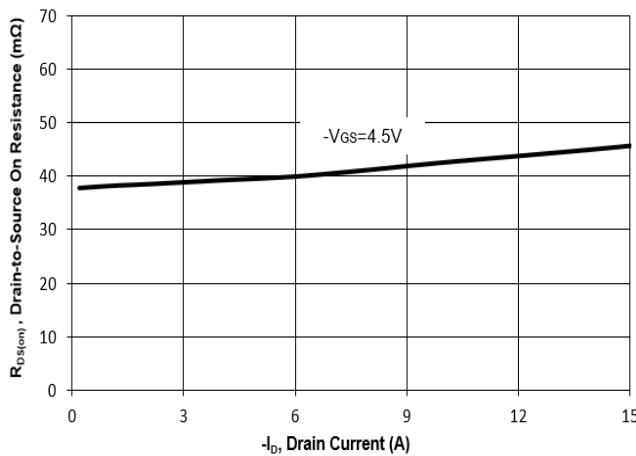


Fig. 5 On-Resistance vs. T_j

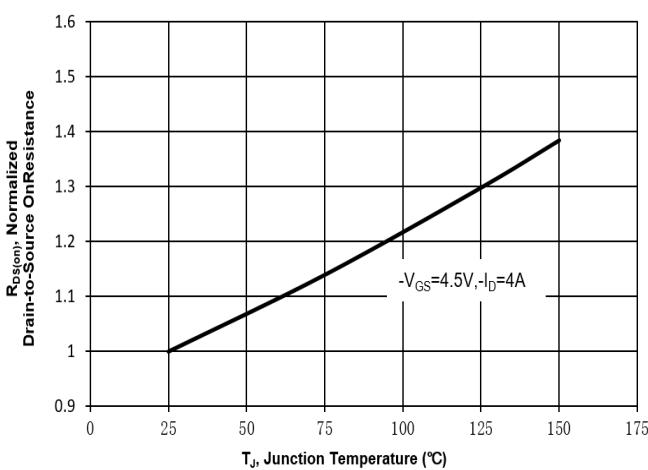


Fig. 2 Typical Transfer Characteristics

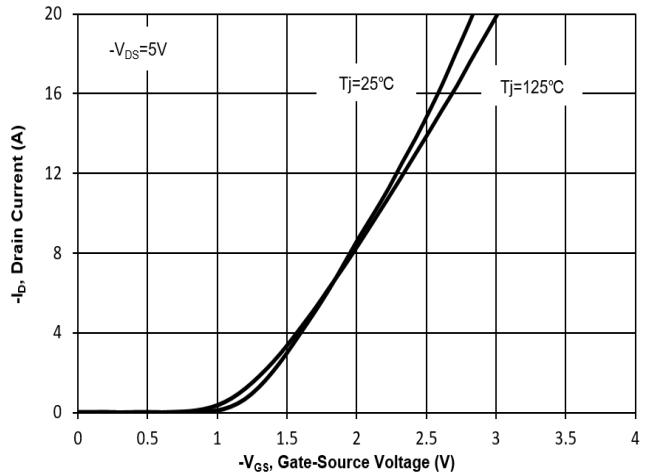


Fig. 4 On-Resistance vs. Gate-Source Voltage

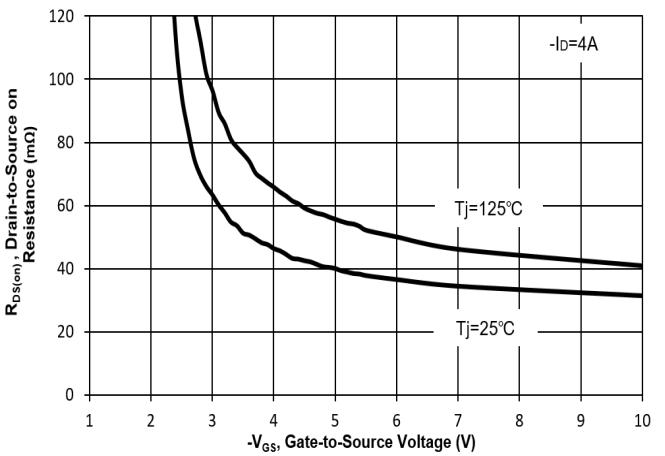
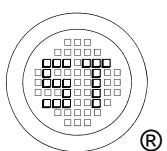
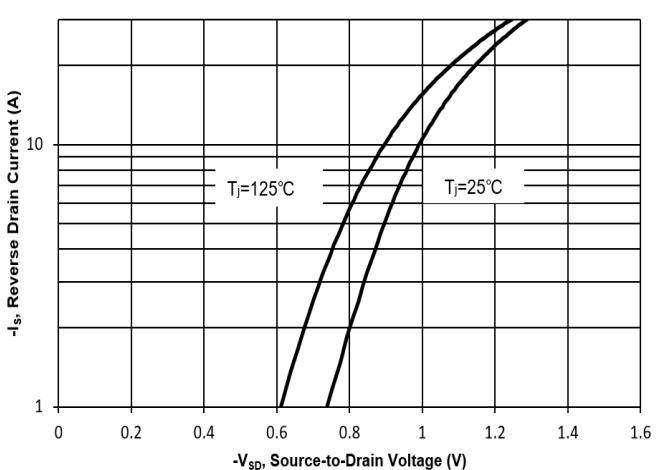


Fig. 6 Typical Body-Diode Forward Characteristics



Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

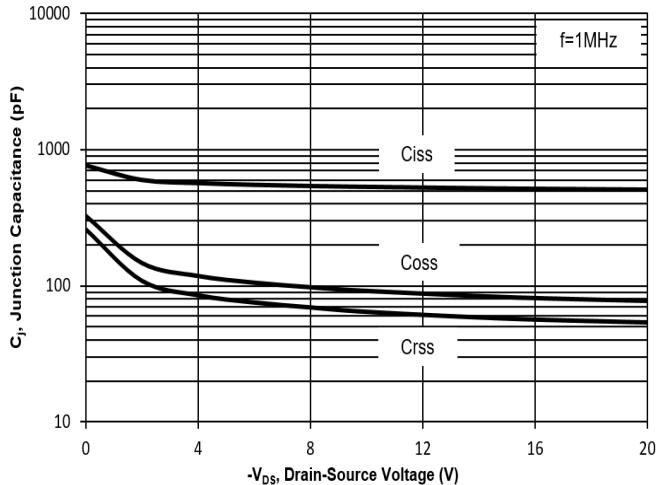


Fig. 8 Drain-Source Leakage Current vs. T_j

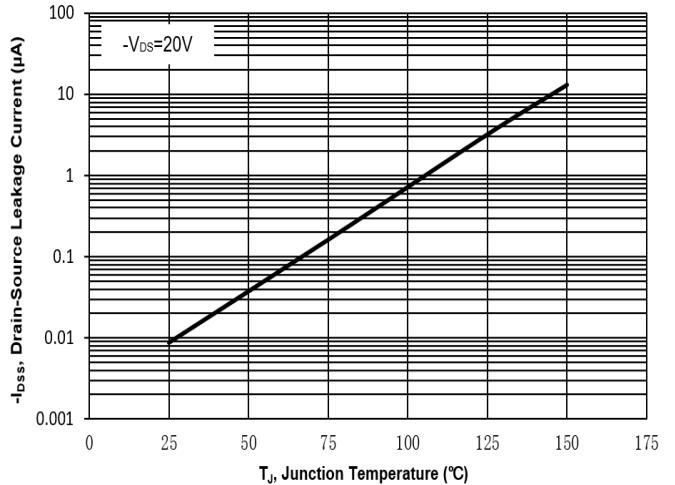


Fig. 9 $V_{(BR)DSS}$ vs. Junction Temperature

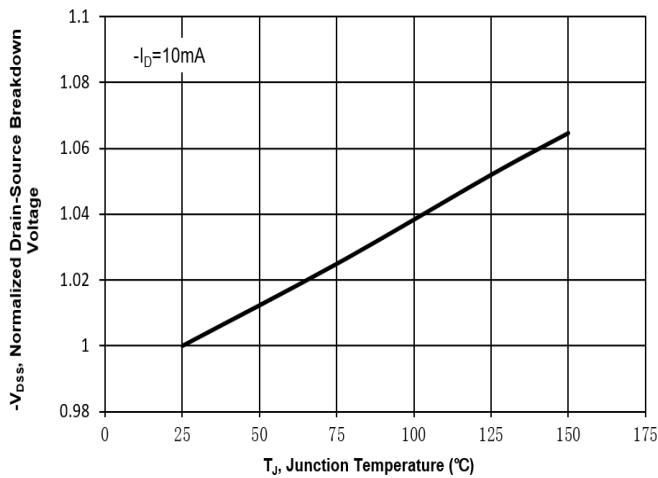


Fig. 10 Gate Threshold Variation vs. T_j

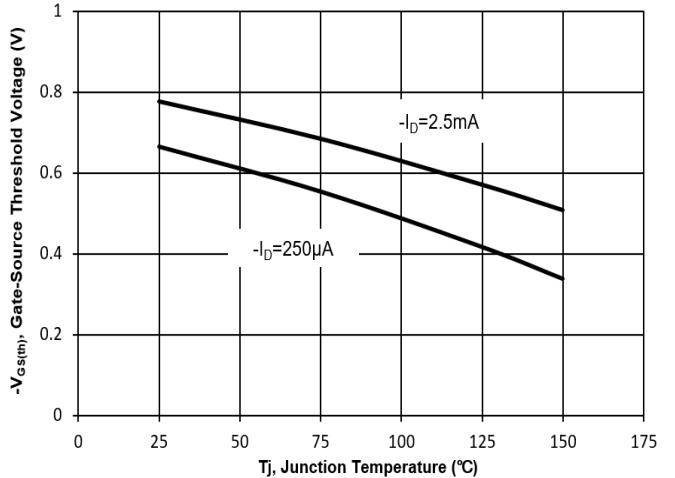
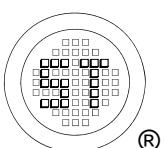
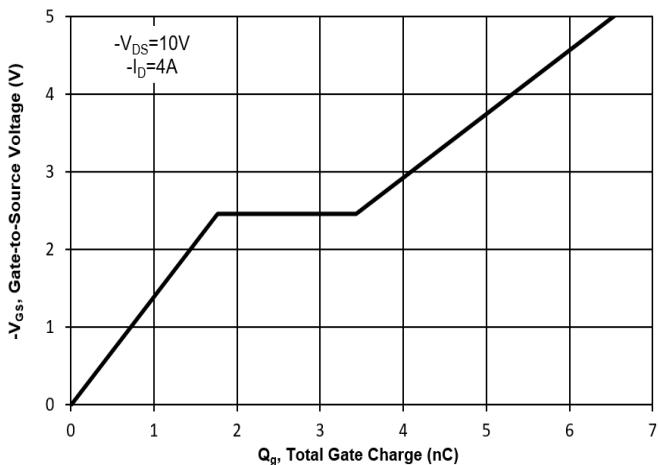


Fig. 11 Gate Charge



Test Circuits

Fig.1-1 Switching times test circuit

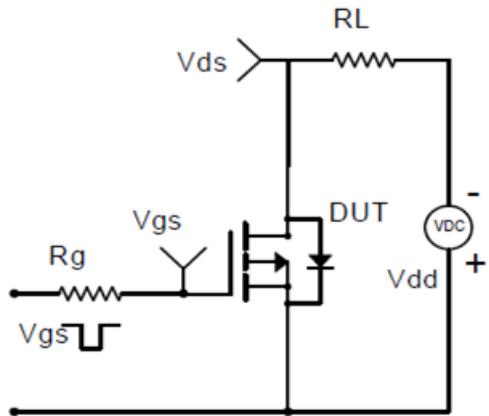


Fig.1-2 Switching Waveform

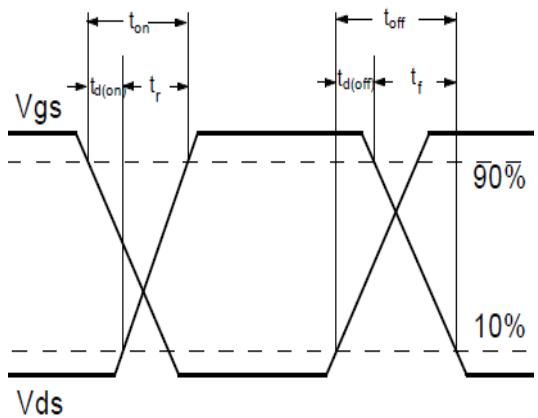


Fig.2-1 Gate charge test circuit

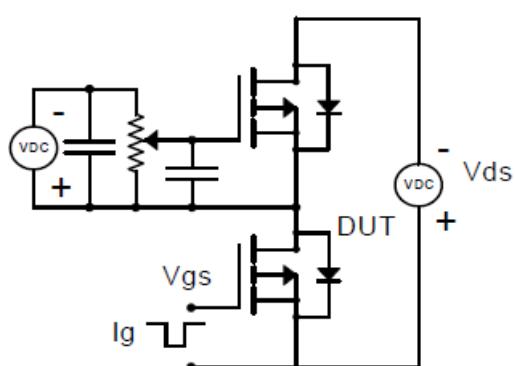
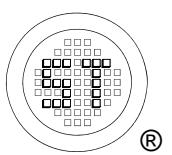
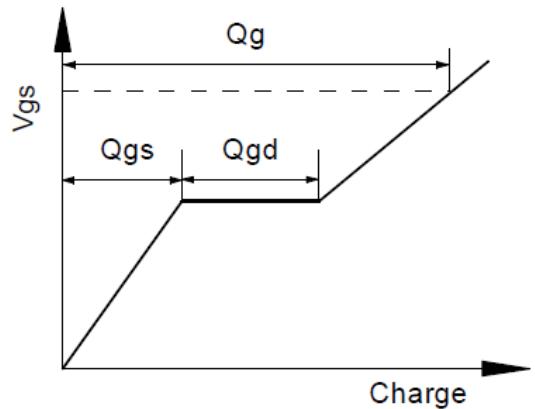


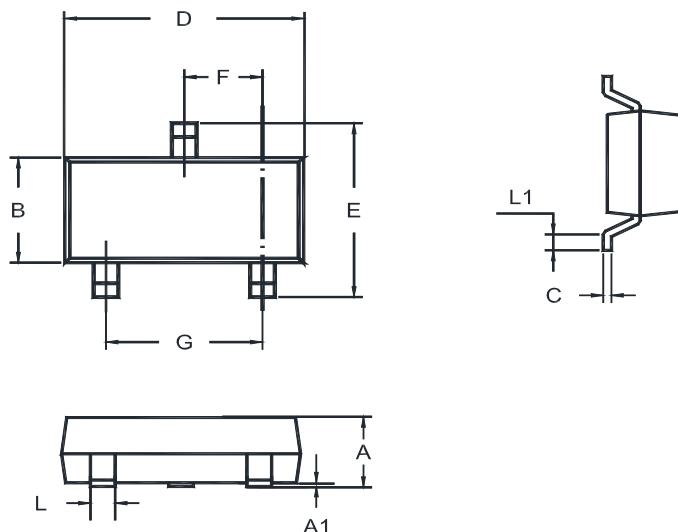
Fig.2-2 Gate charge waveform



MMFTP2317

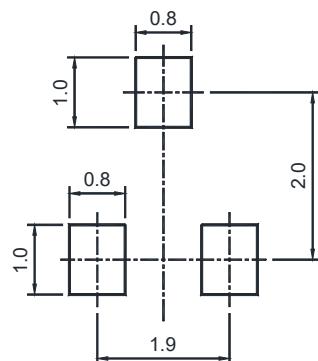
Package Outline (Dimensions in mm)

SOT-23



| Unit | A | A1 | B | C | D | E | F | G | L | L1 |
|------|------|-------|------|------|------|-----|------|------|------|-----|
| mm | 1.20 | 0.100 | 1.40 | 0.19 | 3.04 | 2.6 | 1.02 | 2.04 | 0.51 | 0.2 |
| | 0.89 | 0.013 | 1.20 | 0.08 | 2.80 | 2.2 | 0.89 | 1.78 | 0.37 | MIN |

Recommended Soldering Footprint



Packing information

| Package | Tape Width (mm) | Pitch | | Reel Size | | Per Reel Packing Quantity |
|---------|--------------------|---------|---------------|-----------|------|---------------------------|
| | | mm | inch | mm | inch | |
| SOT-23 | 8 | 4 ± 0.1 | 0.157 ± 0.004 | 178 | 7 | 3,000 |

Marking information

" VS " = Part No.

" YM " = Date Code Marking

" Y " = Year

" M " = Month

Font type: Arial

